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## **Revision history**

**Table 1. Document revision history** 

Date	Version	Changes
24-Aug-2015	1	Initial release.
25-Feb-2016	2	Addition of main heading "LICENSE AGREEMENT". Minor formatting changes.
20-Oct-2017	3	General change.
07-Mar-2018	4	Alignment of document format with the new standard. No change in the license content.

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